Total No. of printed pages = 3 ECE 1816 OE 11 Roll No. of candidate Azara, Hatkhewapara, 2022 Guwahati -781017 B.Tech. 6th Semester End-Term Examination ADVANCED MICROCONTROLLERS (New Regulation and New Syllabus) Full Marks - 70 Time - Three hours The figures in the margin indicate full marks for the questions. Answer Question No. 1 and any four from the rest. Answers may be written for generalized microcontroller. Missing data, if any, should be assumed accordingly. 1. Answer the following (MCQ/ Fill in the blanks): $(10 \times 1 = 10)$ If the starting address of RAM is 8000H and the end address is 8FFFH, size of RAM is-(a) 1 Kb (b) 2 KB (c) 4 KB (d) 8 KB (ii) The flag register in 8051 is called-DPTR (a) (b) **PSW** TCON (c) (d) IE (iii) Default register bank when 8051 is powered on is-Bank 1 (a) (b) Bank 2 (c) Bank 3 (d) Bank 0 Size of the Stack pointer register in 8051 is-(a) 4 bit (b) 6 bit 7 bit (d) 8 bit.

Each port line of a port can individually source a current of up to-

(b)

(d)

0.25 mA

0.75 mA

0.2 mA

(c) $0.5 \, \text{mA}$

(a)

	(vi)	The number of TTL inputs that can be sinked by the port 0 when a logic 0 i sent to a port line as an output port is-				
		(a)	2	(b)	4	
		(c)	6	(d)	8	
	(vii)	The open drain bidirectional (input or output) port with internal pull ups is-				
		(a)	port 0	(b)	port I CHOWDHURY CENTE LIBRI (GIMT & GIPS) Azara, Hatkhowapara,	AR
		(c)	port 2	(d)	port 3 Guwahati -781017	
	(viii) The file register space in PIC are divided in to (PIC 16F877 or PIC18F45					
		(a)	256 bytes bank	(b)	128 bytes bank	
		(c)	64 byte bank	(d)	512 bytes bank	
	(ix)	Fold	back memory is generated in	n-		
		(a)	Linear decoding	(b)	Absolute decoding	
		(c)	Peripheral mapped I/O	(d)	Memory mapped	
	(x)	In an 8-bit processor with 16 bit address lines, the higher and lower order addresses are same in-				
		(a)	Memory mapped I/O	(b)	Linear decoding	
		(c)	Absolute decoding	(d)	Peripheral mapped I/O	
2.	(a)	Compare Embedded system and General computing systems. What are the major area of application of Embedded system. (5)				
	(b)	Explain the working of a four level deep pipelined architecture. (5)				
	(c)	Explain the methodologies adopted for increasing processing speed and reducing power consumption in embedded design. (5)				
3.	(a)	Make a comparative discussion among RISC, CISC and VLIW architecture. (5)				
	(b)	Explain the method of interfacing an external ADC 0848 (or other) with a microcontroller in general. (5)				
	(c)	What are the additional features of PIC over 8051? Describe the Capture-Compare PWM(CCP) module. (5)				
4.	(a)	Write the CAN (Controller area network) protocol ISO 11898-1:2015 standards. (5)				
	(b)	Describe the features that a RTOS must inherit. (5)				(5)
ECH	(c) E 1816		diagram representing the co	ompone	oller based contactless thermomet ents and sensor interconnections. (

- (a) Draw the architecture of 8051. Explain the memory organisation of it. (7)
 (b) Explain the implementation of brown out reset procedure and also its usage with a suitable diagram. (4)
 (c) Implement a watchdog timer and also explain its usage with a suitable
- 6. (a) Discuss the waterfall model in Embedded system design. What are its disadvantages?
 - (b) Describe the memory organization (RAM and ROM) of PIC 16F877 or PIC18F458.

(4)

(c) Using the bit format of the INTCON register of the PIC microcontroller, describe the functions of the individual bits. (5)

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- 7. Write a description of any three of the following.

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 - (a) Relation between embedded system and IOT
 - (b) Use of embedded system in ergonomics
 - (c) $I^2C(I2C)$ protocol

diagram.

(d) Embedded product development life cycle.